

Dual P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY

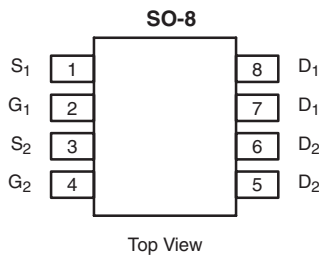
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ)
- 30	0.021 at $V_{GS} = - 10$ V	- 10 ^a	26 nC
	0.031 at $V_{GS} = - 4.5$ V	- 10 ^a	

FEATURES

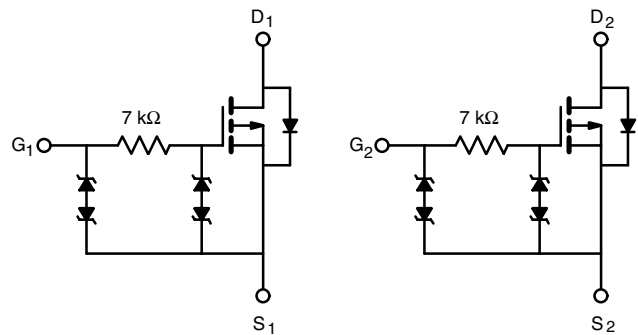
- TrenchFET® Power MOSFET
- ESD Protection: 2500 V

APPLICATIONS

- Load Switch for Portable Devices
- Battery and Load Switching for Notebooks


RoHS
COMPLIANT


Ordering Information: Si4941EDY-T1-E3 (Lead (Pb)-free)



ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	- 30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 150^\circ\text{C}$)	I_D	$T_C = 25^\circ\text{C}$ - 10 ^a	A
		$T_C = 70^\circ\text{C}$ - 8.8	
		$T_A = 25^\circ\text{C}$ - 8.3 ^{b, c}	
		$T_A = 70^\circ\text{C}$ - 6.6 ^{b, c}	
Pulsed Drain Current	I_{DM}	- 30	A
Continuous Source-Drain Diode Current	I_S	- 3	
		$T_A = 25^\circ\text{C}$ - 1.7 ^{b, c}	
Maximum Power Dissipation	P_D	$T_C = 25^\circ\text{C}$ 3.6	W
		$T_C = 70^\circ\text{C}$ 2.3	
		$T_A = 25^\circ\text{C}$ 2 ^{b, c}	
		$T_A = 70^\circ\text{C}$ 1.3 ^{b, c}	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, c}	R_{thJA}	45	62.5	$^\circ\text{C/W}$
Maximum Junction-to-Foot (Drain)	R_{thJF}	26	35	

Notes:

- Package limited.
- Surface Mounted on 1" x 1" FR4 board.
- $t = 10$ s.
- Maximum under Steady State conditions is 110 $^\circ\text{C/W}$

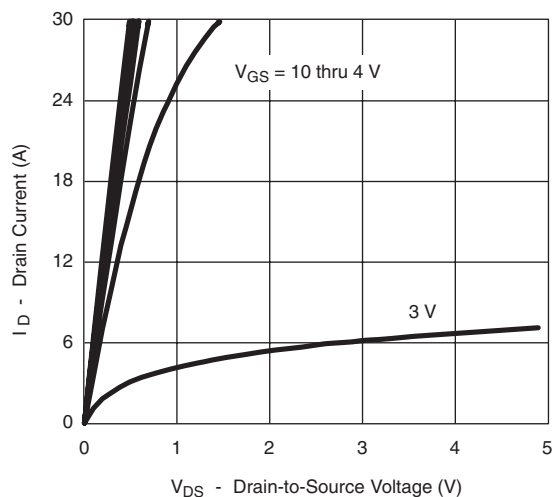
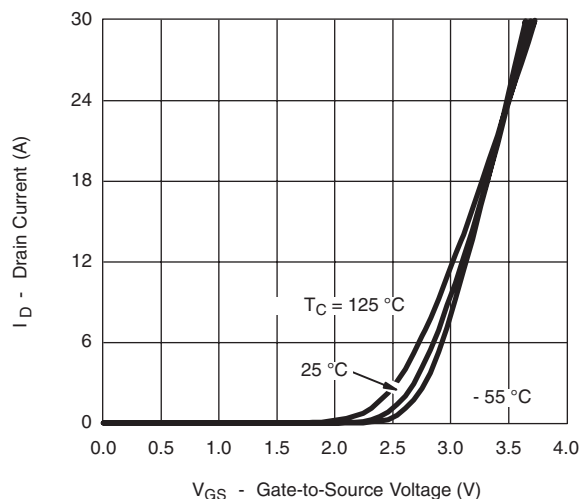
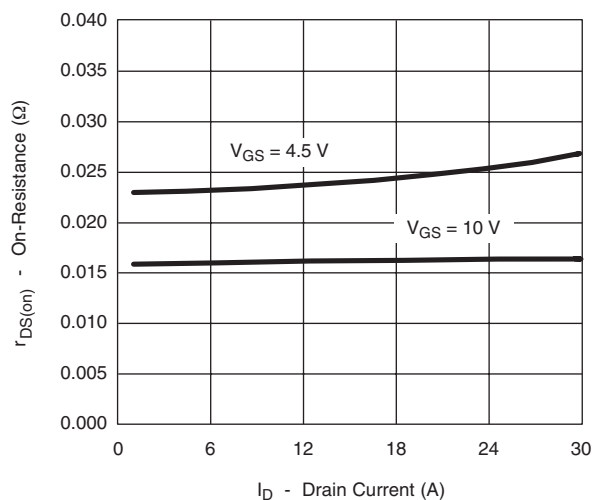
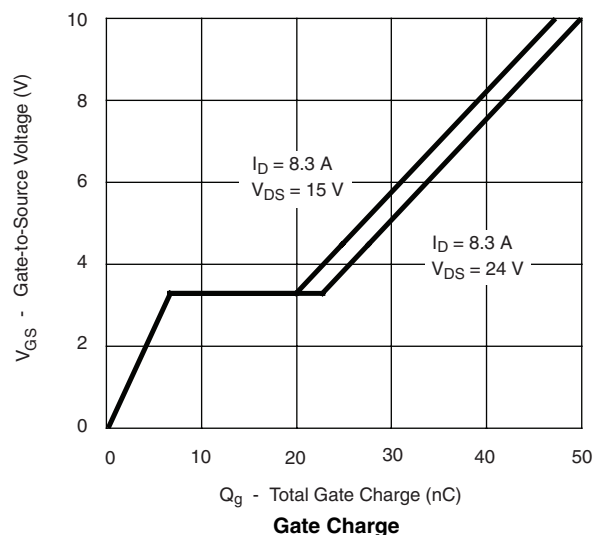
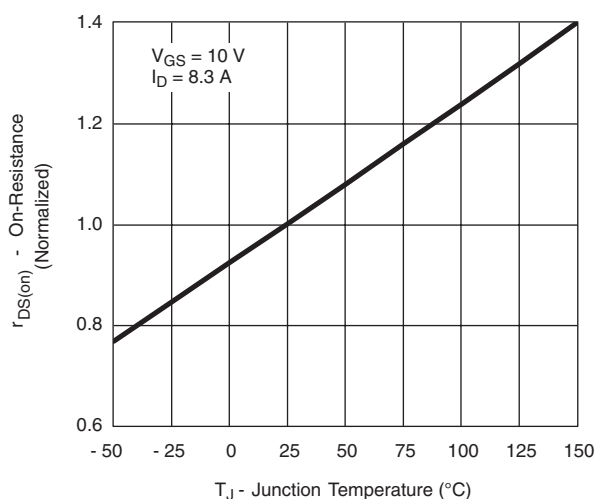
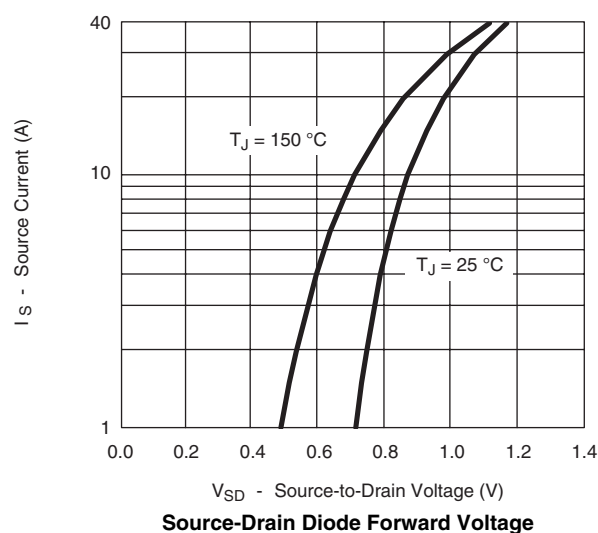
SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = - 250 μA		- 33		mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J			4.2		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 1.2		- 2.8	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 10 V			± 20	μA
		V _{DS} = 0 V, V _{GS} = ± 20 V			± 1	mA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μA
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≤ - 5 V, V _{GS} = - 10 V	- 30			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 8.3 A		0.017	0.021	Ω
		V _{GS} = - 4.5 V, I _D = - 6.8 A		0.025	0.031	
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 8.3 A		26		S
Dynamic ^b						
Total Gate Charge	Q _g	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 8.3 A		46	70	nC
		V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 8.3 A		26	39	
Gate-Source Charge	Q _{gs}			6.7		
Gate-Drain Charge	Q _{gd}			14		
Gate Resistance	R _g	f = 1 MHz		7.3		kΩ
Turn-on Delay Time	t _{d(on)}	V _{DD} = - 15 V, R _L = 2.3 Ω I _D ≅ - 6.6 A, V _{GEN} = - 4.5 V, R _g = 1 Ω		16	24	μs
Rise Time	t _r			60	90	
Turn-Off Delay Time	t _{d(off)}			11	17	
Fall Time	t _f			24	36	
Turn-on Delay Time	t _{d(on)}	V _{DD} = - 15 V, R _L = 2.3 Ω I _D ≅ - 6.6 A, V _{GEN} = - 10 V, R _g = 1 Ω		5.5	9	
Rise Time	t _r			11	20	
Turn-Off Delay Time	t _{d(off)}			30	45	
Fall Time	t _f			24	40	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 10	A
Pulse Diode Forward Current	I _{SM}				30	
Body Diode Voltage	V _{SD}	I _S = - 2.1 A, V _{GS} = 0 V		- 0.83	- 1.2	V

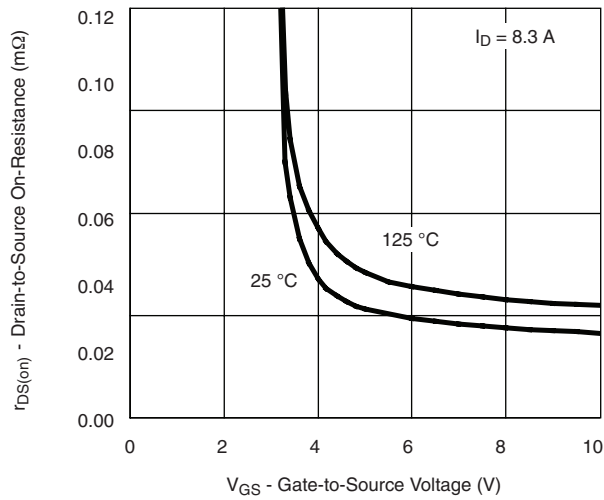
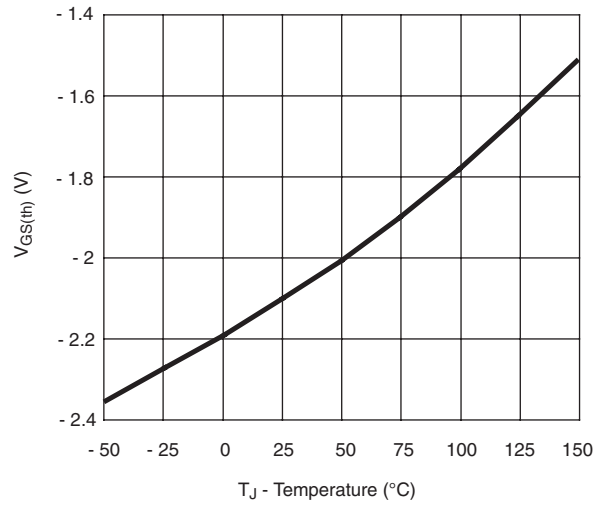
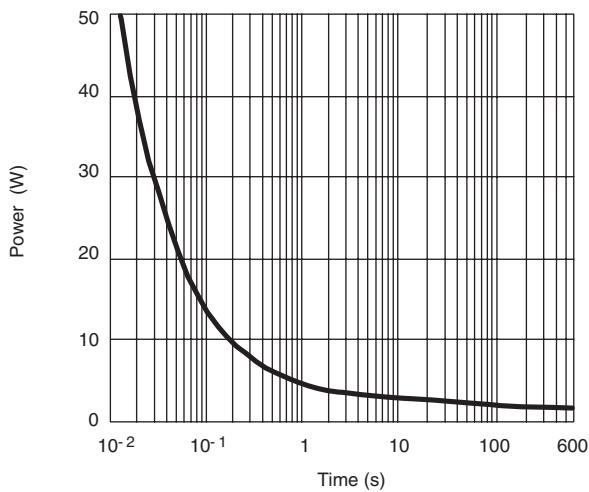
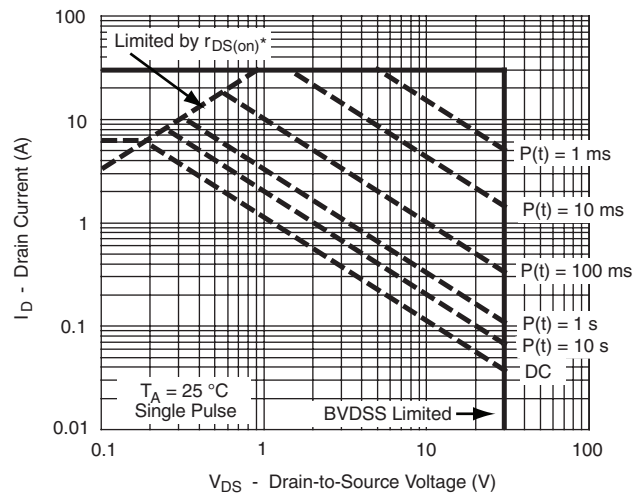
Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

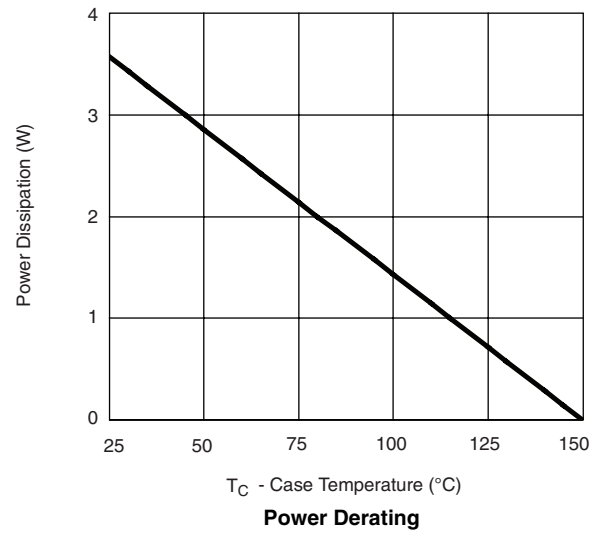
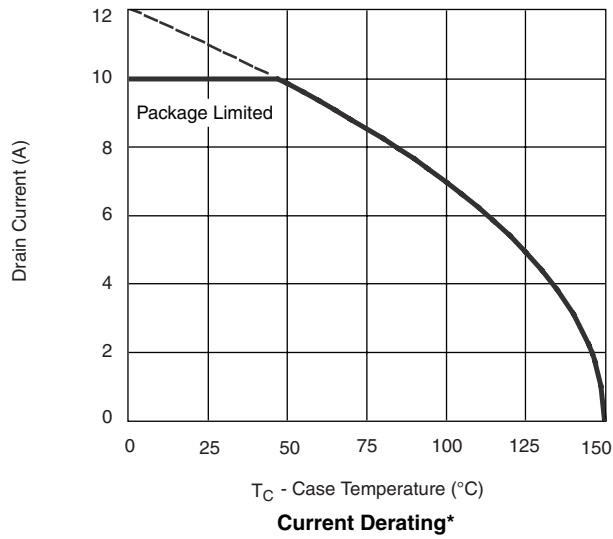
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Output Characteristics****Transfer Characteristics****On-Resistance vs. Drain Current****Gate Charge****On-Resistance vs. Junction Temperature****Source-Drain Diode Forward Voltage**

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted**On-Resistance vs. Gate-Source Voltage****Threshold Variance****Single Pulse Power**

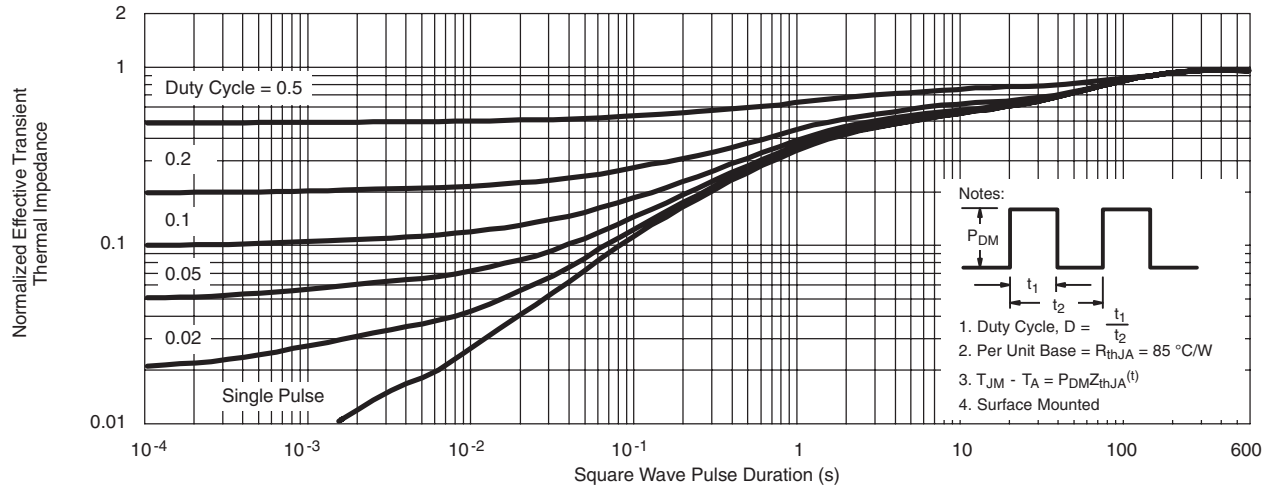
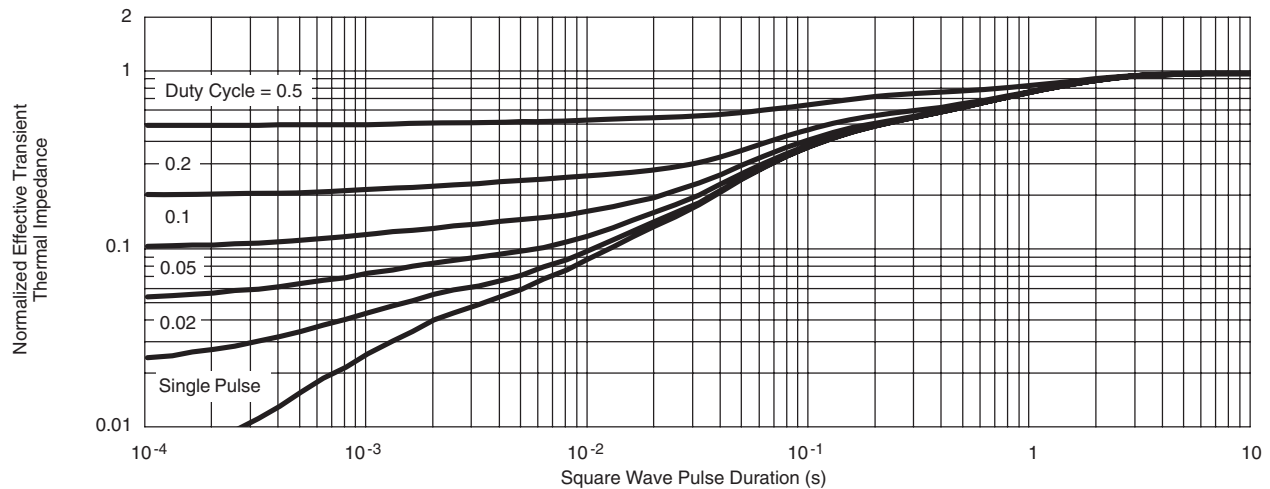
* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified
Safe Operating Area



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Foot**

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